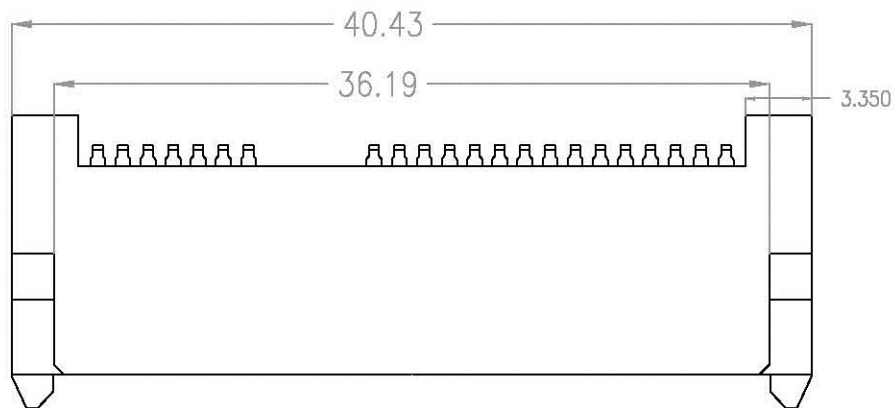


SPECIFICATION:

1 MATERIAL:

HOUSING:LCP E130i 30% G/F UL 94V-0

COLOR:BLACK

CONTACT:BRASS C5191R EH,T=0.25mm

PEG: BRASS C2680R H,T=0.30mm

2 FINISH:

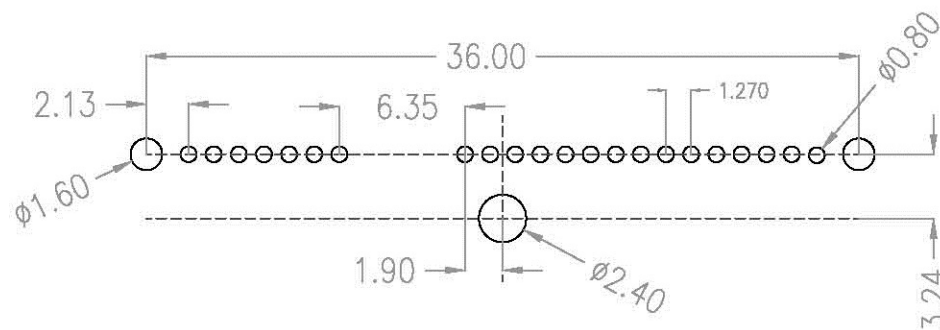
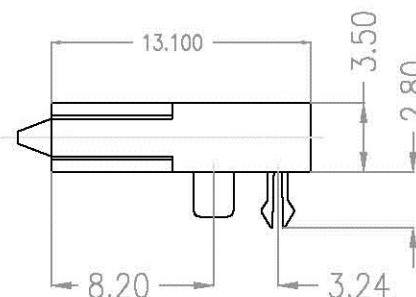
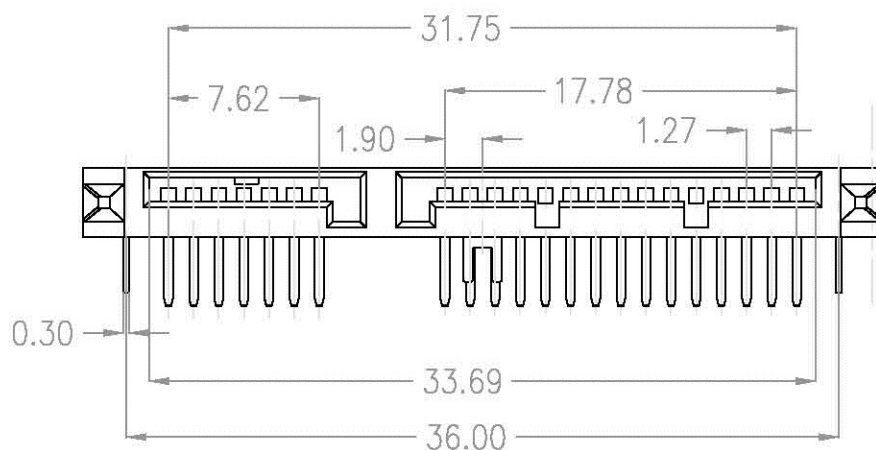
CONTACT: 3u" GOLD/TIN PLATING ON CONTACT AREA

100u" MIN. TIN-LEAD PLATING ON SOLDERTAILS

50u" MIN. NICKEL UNDERPLATING OVERALL

PEG:100u" MIN. TIN-LEAD PLATING ON SOLDERTAILS

50u" MIN. NICKEL UNDERPLATING OVERALL



PCB LAYOUT (H=1.60mm)
PCB TOLERANCE:±0.05

L&X 深圳市连欣科技有限公司

X. ±0.15 X.X ±0.10 X.XX ±0.05 X.XXX ±0.010 X.* ±5* X.X* ±1*	DRAWN BY:	DATE:	PART NAME:	
	宁夏	07/23/07	SATA7+15P 单排90度 H: 3.5	
UNIT: mm [Inch] SCALE: 1:1 SIZE: A4	CHECKED BY:	DATE:	PART NO.	XUTS-2209-0358
	黄宏清	07/24/07	MOLD NO.	
	APPROVAL BY:	DATE:	PRODUCT SPEC.	
	Welsent do	07/26/07	DRAW NO.	